PROCEEDINGS OF SPIE

Image Sensing Technologies: Materials, Devices, Systems, and Applications XII

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Editors

14–16 April 2025
Orlando, Florida, United States

Sponsored and Published by
SPIE

Volume 13454

Proceedings of SPIE 0277-786X, V. 13454

SPIE is an international society advancing an interdisciplinary approach to the science and application of light.

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Author(s), "Title of Paper," in *Image Sensing Technologies: Materials, Devices, Systems, and Applications XII*, edited by Nibir K. Dhar, Achyut K. Dutta, Sachidananda R. Babu, Proc. of SPIE 13454, Seven-digit Article CID Number (DD/MM/YYYY); (DOI URL).

ISSN: 0277-786X
ISSN: 1996-756X (electronic)

ISBN: 9781510686977
ISBN: 9781510686984 (electronic)

Published by
SPIE
P.O. Box 10, Bellingham, Washington 98227-0010 USA
Telephone +1 360 676 3290 (Pacific Time)
SPIE.org
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